

Description

The AP30N06Y uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

 $V_{DS} = 60V I_{D} = 30A$

 $R_{DS(ON)}$ <36m Ω @ V_{GS} =10V (Type: 28m Ω)

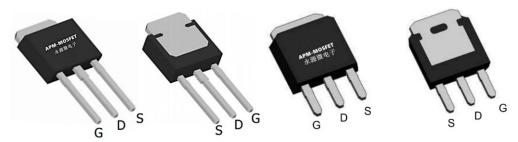
D APM AP30N06Y XXX YYYY

Application

LED lamp

Load switch

Uninterruptible power supply



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP30N06Y	TO-251L-3L	AP30N06Y XXXX YYYY	4000
AP30N06Y	TO-251S-3L	AP30N06Y XXXX YYYY	4000

Absolute Maximum Ratings@T_i=25°C(unless otherwise specified)

Symbol	Parameter	Max.	Units
VDSS	Drain-Source Voltage	60	V
VGSS	Gate-Source Voltage	Sate-Source Voltage ±20	
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	30	Α
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	13	Α
IDM	Pulsed Drain Current	74	Α
IAS	Avalanche Current	13	A
EAS	Single Pulsed Avalanche Energy	22	mJ
P _D @T _C =25°C	Power Dissipation	31.3	W
TJ, TSTG	Operating and Storage Temperature Range	-55 to +175	°C
R _θ JA	Thermal Resistance Junction-Ambient ¹	62	°C/W
R₀JC	Thermal Resistance Junction-Case ¹	4	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit	
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	60	65		V	
∆BVDSS/∆TJ	BVDSS Temperature Coefficient Reference to 25°C , I _D =1mA			0.044		V/°C	
RDS(ON)	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =15A		28	36	mΩ	
ND3(ON)	Static Dialii-Source Oil-Nesistance	V _{GS} =4.5V , I _D =7A		38	45	mΩ	
VGS(th)	Gate Threshold Voltage	\/ -\/ -250··A	1.2	1.6	2.5	V	
$\triangle V_{GS(th)}$	$V_{\text{GS(th)}}$ Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250uA$		-4.8		mV/°C	
IDSS	Drain Source Leakage Current	V _{DS} =48V , V _{GS} =0V , T _J =25°C			1	uA	
1033	Drain-Source Leakage Current	V _{DS} =48V , V _{GS} =0V , T _J =55°C			5		
IGSS	Gate-Source Leakage Current	V_{GS} =±20 V , V_{DS} =0 V			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =15A		25.3		S	
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		2.5		Ω	
Qg	Total Gate Charge (10V)			19			
Q _{gs}	Gate-Source Charge	V _{DS} =48V , V _{GS} =10V , I _D =15A		2.5		nC	
Q _{gd}	Gate-Drain Charge			5			
Td(on)	Turn-On Delay Time			2.8			
Tr	Rise Time	V_{DD} =30V , V_{GS} =10V , R_{G} =3.3 Ω		16.6		ne	
Td(off)	Turn-Off Delay Time	I _D =15A		21.2		ns	
T _f	Fall Time			5.6			
Ciss	Input Capacitance			1027			
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		65		pF	
Crss	Reverse Transfer Capacitance			46			
Is	Continuous Source Current ^{1,6}				20	Α	
ISM	Pulsed Source Current ^{2,6}	V _G =V _D =0V , Force Current			40	Α	
VSD	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.2	V	
t _{rr}	Reverse Recovery Time	IF=15A , dI/dt=100A/μs ,		12.2		nS	
Qrr	Reverse Recovery Charge	T _J =25°C		7.3		nC	

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- $2\sqrt{100}$ The data tested by pulsed , pulse width .The EAS data shows Max. rating .
- 3. The test cond \leq 300us duty cycle \leq 2%, duty cycle ition is TJ =25°C, VDD =48V, VG =10V, RG =25 Ω , L=0.1mH, IAS =13A
- 4. The power dissipation is limited by 175°C junction temperature
- 5. The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.



Typical Characteristics

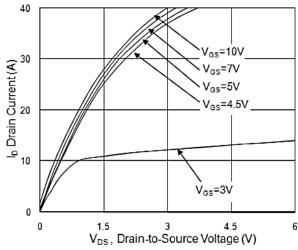


Fig.1 Typical Output Characteristics

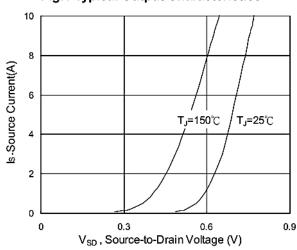


Fig.3 Forward Characteristics Of Reverse

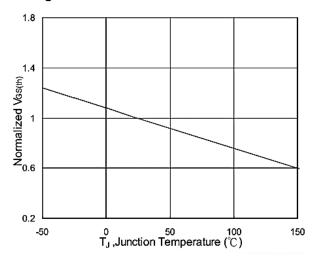


Fig.5 Normalized V_{GS(th)} vs. T_J

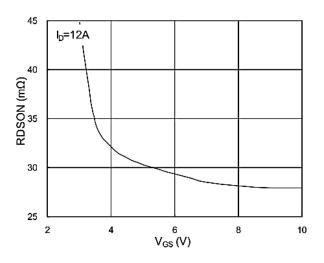


Fig.2 On-Resistance vs. Gate-Source

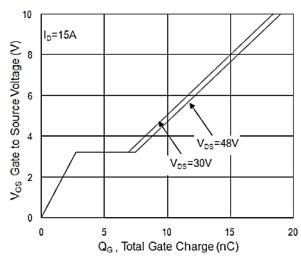


Fig.4 Gate-Charge Characteristics

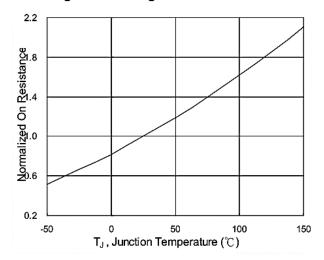
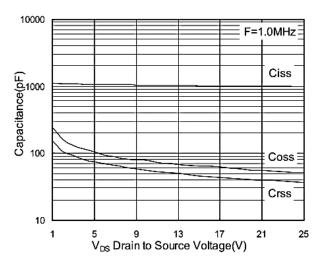


Fig.6 Normalized R_{DSON} vs. T_J







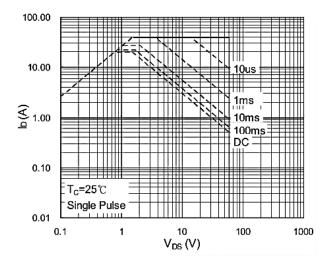


Fig.7 Capacitance

Fig.8 Safe Operating Area

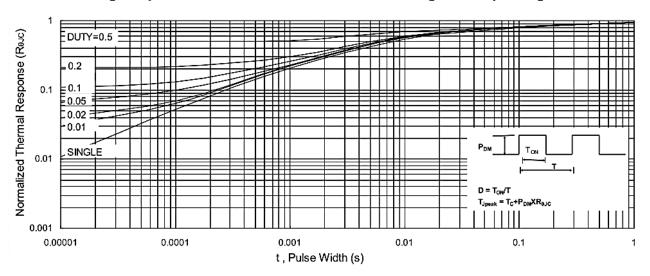


Fig.9 Normalized Maximum Transient Thermal Impedance

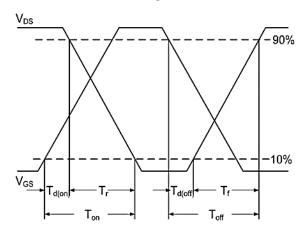


Fig.10 Switching Time Waveform

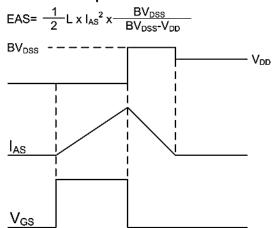
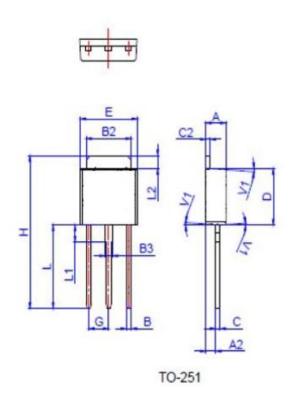


Fig.11 Unclamped Inductive Switching Waveform



Package Mechanical Data-TO-251L-3L



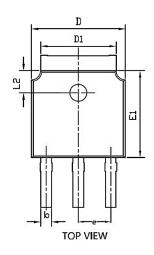
	Dimensions						
Ref. Min		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	2.20		2.40	0.086		0.095	
A2	0.90		1.20	0.035		0.047	
В	0.55		0.65	0.022		0.026	
B2	5.10		5.40	0.200		0.213	
B3	0.76		0.85	0.030		0.033	
С	0.45		0.62	0.018		0.024	
C2	0.48		0.62	0.019		0.024	
D	6.00		6.20	0.236		0.244	
Е	6.40		6.70	0.252		0.264	
G		2.30			0.091		
Н	16.0		17.0	0.630		0.669	
L	8.90		9.40	0.350		0.370	
L1	1.80		1.90	0.071		0.075	
L2	1.37		1.50	0.054		0.059	
V1		4°			4°		

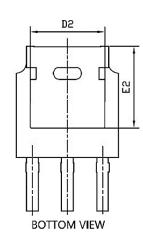
Package Information -TO-251

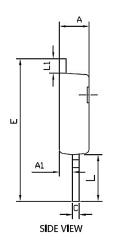
OUTLINE	TUBE	INNER BOX	PER CARTON
	(PCS)	(PCS)	(PCS)
TUBE	80	4,000	32,000



Package Mechanical Data-TO-251S-3L







	Common				
Symbol	mm				
	Mim	Nom	Max		
Α	2.2	2.3	2.4		
A1	0.9	1.0	1.1		
b	0.66	0.76	0.86		
С	0.46	0.52	0.58		
D	6.50	6.6	6.7		
D1	5.15	5.3	5.45		
D2	4.6	4.8	4.95		
E	10.4		11.5		
E1	6.0	6.1	6.2		
E2	5.400REF				
е	2.286BSC				
L	3.5	4.0	4.3		
L1	0.9		1.27		
L2	1.4		1.9		



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AP30N06Y

60V N-Channel Enhancement Mode MOSFET

Edition	Date	Change
Rve1.0	2021/10/29	Initial release

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